

## **Si3454DV**

# N-Channel PowerTrench® MOSFET

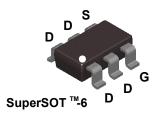
## **General Description**

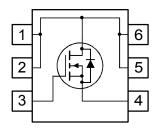
These N-Channel Logic Level MOSFETs are produced using Fairchild Semiconductor's advanced Power Trench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

#### **Features**

- 4.2 A, 30 V.  $R_{DS(ON)} = 65 \text{ m}\Omega$  @  $V_{GS} = 10 \text{ V}$   $R_{DS(ON)} = 95 \text{ m}\Omega$  @  $V_{GS} = 4.5 \text{ V}$
- High performance trench technology for extremely low  $R_{\mbox{\scriptsize DS(ON)}}$
- Low gate charge (9.4 nC typical)
- · High power and current handling capability





Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		30	V
$V_{GSS}$	Gate-Source Voltage		±20	V
I <sub>D</sub>	Drain Current - Continuous	(Note 1a)	4.2	А
	- Pulsed		20	
$P_D$	Maximum Power Dissipation	(Note 1a)	1.6	W
		(Note 1b)	0.8	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Tem	perature Range	-55 to +150	°C

## **Thermal Characteristics**

R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case	(Note 1)	30	°C/W

**Package Marking and Ordering Information** 

Device Marking	Device	Reel Size	Tape width	Quantity
.454	Si3454DV	7"	8mm	3000 units

Symbol Parameter		T <sub>A</sub> = 25°C unless otherwise noted  Test Conditions Min Typ Max				
		rest conditions	IVIIII	тур	wax	Units
Off Char	acteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V},  I_D = 250 \mu\text{A}$	30			V
<u>ΔBV<sub>DSS</sub></u> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, Referenced to 25°C		20		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70^{\circ}\text{C}$			25	
I <sub>GSSF</sub>	Gate–Body Leakage, Forward	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage, Reverse	V <sub>GS</sub> = -20 V, V <sub>DS</sub> = 0 V			-100	nA
On Char	acteristics (Note 2)					
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.5	2	V
$\Delta V_{GS(th)} \ \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, Referenced to 25°C		- 4		mV/°C
$R_{DS(on)}$	Static Drain–Source On–Resistance	$V_{GS} = 10 \text{ V}, I_D = 4.2 \text{ A}$ $V_{GS} = 4.5 \text{ V}, I_D = 3.4 \text{ A}$		33 44	65 95	mΩ
I <sub>D(on)</sub>	On–State Drain Current	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 5 V	15			Α
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = 10 \text{ V}, I_{D} = 4.2 \text{ A}$		10		S
Dvnamio	Characteristics	1		I		I
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V,		460		pF
Coss	Output Capacitance	f = 1.0 MHz		115		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1		45		pF
Switchin	g Characteristics (Note 2)			•		
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DS} = 15 \text{ V},  I_{D} = 1 \text{ A},$		5	20	nS
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = 10 \text{ V},  R_{GEN} = 6 \Omega$		8	30	nS
t <sub>d(off)</sub>	Turn-Off Delay Time	1		17	35	nS
t <sub>f</sub>	Turn–Off Fall Time	1		13	20	nS
t <sub>rr</sub>	Source-Drain Reverse Recovery Time	I <sub>F</sub> = 1.7 A, di/dt = 100 A/uS			80	nS
Qg	Total Gate Charge	$V_{DS} = 10 \text{ V}, I_{D} = 4.2 \text{ A},$		9.4	15	nC
$Q_{gs}$	Gate-Source Charge	V <sub>GS</sub> = 10 V		1.2		nC
$Q_{gd}$	Gate-Drain Charge			1.1		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain-Source				1.7	Α
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 1.7 A (Note 2)			1.2	V

#### Notes:

- R<sub>0,JA</sub> is the sum of the junction-to-case and case-to-ambient resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0,C</sub> is guaranteed by design while R<sub>0,CA</sub> is determined by the user's board design.
  - a.  $78^{\circ}\text{C/W}$  when mounted on a  $1\text{in}^2$  pad of 2oz copper on FR-4 board.
  - b. 156°C/W when mounted on a minimum pad.
- 2. Pulse Test: Pulse Width  $\leq 300~\mu s,~Duty~Cycle \leq 2.0\%$

Typical Characteristics	
Figure 1. On-Region Characteristics.	Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.
Figure 3. On-Resistance Variation withTemperature.	Figure 4. On-Resistance Variation with Gate-to-Source Voltage.
Figure 5. Transfer Characteristics.	Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.



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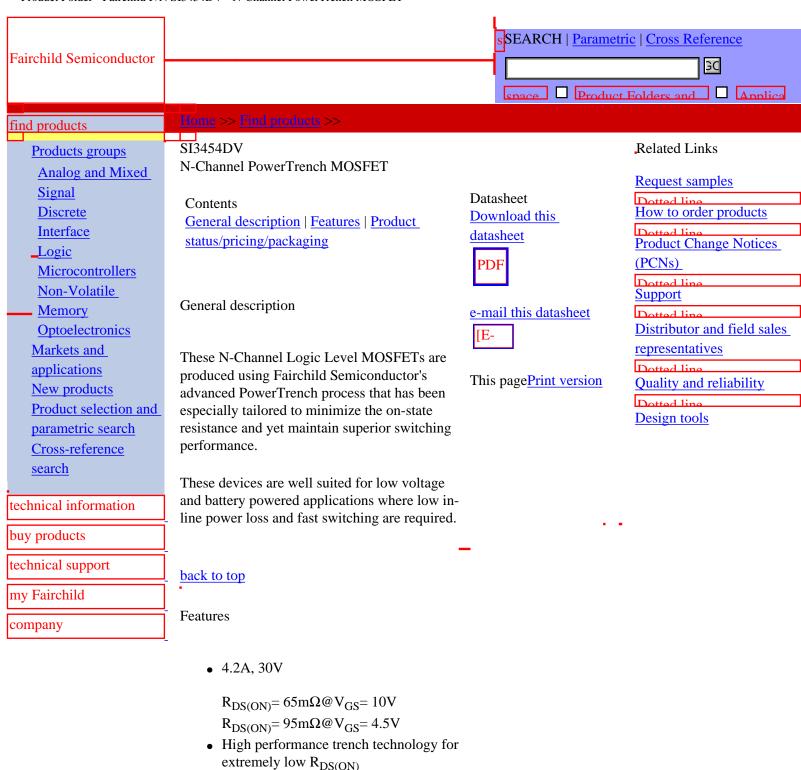
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Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
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Rev. H4



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Product status/pricing/packaging

capability

Low gate charge (9.4 nC typical)High power and current handling

Product	<b>Product status</b>	Pricing*	Package type	Leads	Package marking	Packing method
SI3454DV	Full Production	\$0.346	SuperSOT	6	.454	TAPE REEL

Product Folder - Fairchild P/N SI3454DV - N-Channel PowerTrench MOSFET
* 1,000 piece Budgetary Pricing
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